

#### **Automotive MOSFET**

#### OptiMOS™ 7 Power-Transistor







#### **Features**

- OptiMOS<sup>™</sup> power MOSFET for automotive applications
- N-channel Enhancement mode Normal Level
- Extended qualification beyond AEC-Q101
- Enhanced electrical testing
- Robust design
- MSL1 up to 260°C peak reflow
- 175°C operating temperature
- RoHS compliant
- 100% Avalanche tested

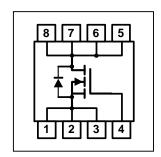
#### **Potential applications**

General automotive applications.

#### **Product validation**

Qualified for automotive applications. Product validation according to AEC-Q101.





#### **Product Summary**

$V_{\mathrm{DS}}$	40	V
R <sub>DS(on)</sub>	0.96	mΩ
I <sub>D</sub> (chip limited)	268	Α

Туре	Package	Marking
IAUCN04S7N009	PG-TDSON-8-34	7N04N009

## IAUCN04S7N009



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# **Maximum ratings**

at Tj=25 °C, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Continuous drain current	I D	V <sub>GS</sub> =10 V, Chip limitation <sup>1,2)</sup>	268	А
		V <sub>GS</sub> =10V, DC current	175	
		$T_a$ =100 °C, $V_{GS}$ =10 V, $R_{thJA}$ on 2s2p <sup>2,3)</sup>	39	
Pulsed drain current <sup>2)</sup>	I <sub>D,pulse</sub>	T <sub>C</sub> =25 °C, t <sub>p</sub> = 100 μs	820	]
Avalanche energy, single pulse <sup>2)</sup>	E AS	I <sub>D</sub> =67 A	145	mJ
Avalanche current, single pulse	I <sub>AS</sub>	-	133	А
Gate source voltage	V <sub>GS</sub>	-	±20	V
Power dissipation	P <sub>tot</sub>	Т <sub>C</sub> =25 °С	129	W
Operating and storage temperature	$T_{\rm j}$ , $T_{\rm stg}$	-	-55 <b>+</b> 175	°C

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# Thermal characteristics<sup>2)</sup>

Parameter	Symbol	Conditions		Values		
			min.	typ.	max.	
Thermal resistance, junction - case	R thJC	-	-	0.6	1.2	K/W
Thermal resistance, junction - ambient <sup>3)</sup>	R <sub>thJA</sub>	-	-	27	-	

## **Electrical characteristics**

at Tj=25 °C, unless otherwise specified

Parameter	Symbol	Conditions		Values		Unit
			min.	typ.	max.	
Static characteristics						
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	$V_{GS}$ =0 V, $I_D$ =1 mA	40	_	-	V
Gate threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 60 \mu A$	2.2	2.6	3.0	
Zero gate voltage drain current	I <sub>DSS</sub>	$V_{DS}$ =40 V, $V_{GS}$ =0 V, $T_{j}$ =25 °C	_	_	1	μΑ
		$V_{DS}$ =40 V, $V_{GS}$ =0 V, $T_{j}$ =100 °C <sup>2)</sup>	-	-	14	
Gate-source leakage current	I <sub>GSS</sub>	V <sub>GS</sub> =20 V, V <sub>DS</sub> =0 V	-	-	100	nA
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> =7 V, I <sub>D</sub> =44 A	-	1.05	1.20	mΩ
		V <sub>GS</sub> =10 V, I <sub>D</sub> =88 A	-	0.86	0.96	
Gate resistance <sup>2)</sup>	R <sub>G</sub>	-	_	1.2	-	Ω

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Parameter	Symbol Conditions		Values			Unit
			min.	typ.	max.	]
Dynamic characteristics <sup>2)</sup>						
Input capacitance	C iss		-	3892	5060	pF
Output capacitance	C oss	$V_{GS}$ =0 V, $V_{DS}$ =20 V, $f$ =1 MHz	-	2264	2940	
Reverse transfer capacitance	C <sub>rss</sub>		-	75	113	
Turn-on delay time	t <sub>d(on)</sub>		_	8	_	ns
Rise time	t <sub>r</sub>	$V_{\rm DD}$ =20 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =88 A,	_	6	_	
Turn-off delay time	t <sub>d(off)</sub>	$R_{\rm G}$ =3.5 $\Omega$	-	22	_	
Fall time	t f		_	13	_	
Gate to source charge  Gate to drain charge  Gate charge total	Q gs Q gd	$V_{DD}$ =20 V, $I_{D}$ =88 A, $V_{GS}$ =0 to 10 V	-	16 11 57	21 17 74	nC
Gate charge total	Q <sub>g</sub>		_	57	74	
Gate plateau voltage	$V_{ m plateau}$		-	4.2	-	V
Reverse Diode						
Diode continous forward current <sup>2)</sup>	I <sub>S</sub>	T <sub>C</sub> =25 °C	-	_	175	Α
Diode pulse current <sup>2)</sup>	/ <sub>S,pulse</sub>	T <sub>C</sub> =25 °C, t <sub>p</sub> = 100 μs	-	-	820	
Diode forward voltage	V <sub>SD</sub>	$V_{\rm GS}$ =0 V, $I_{\rm F}$ =88 A, $T_{\rm j}$ =25 °C	1	0.8	0.95	V
Reverse recovery time <sup>2)</sup>	t rr	V <sub>R</sub> =20 V, I <sub>F</sub> =50A,	_	40	60	ns
Reverse recovery charge <sup>2)</sup>	Q rr	$di_{F}/dt = 100 \text{ A/}\mu\text{s}$	_	31	63	nC

<sup>&</sup>lt;sup>1)</sup> Practically the current is limited by the overall system design including the customer-specific PCB.

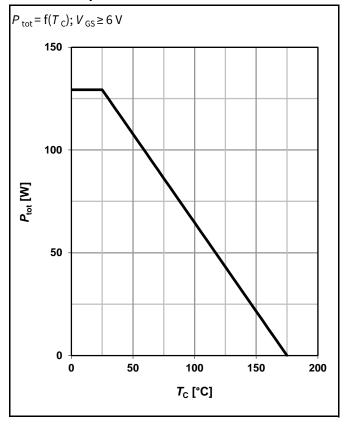
<sup>&</sup>lt;sup>2)</sup> The parameter is not subject to production testing – specified by design.

<sup>&</sup>lt;sup>3)</sup> Device on 2s2p FR4 PCB defined in accordance with JEDEC standards (JESD51-5, -7). PCB is vertical in still air.

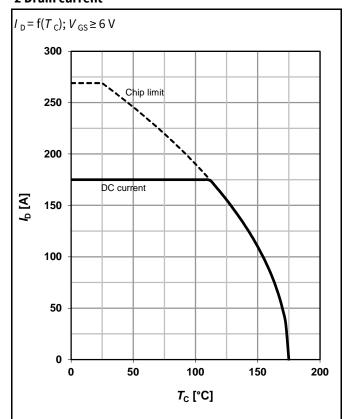


## **Electrical characteristics diagrams**

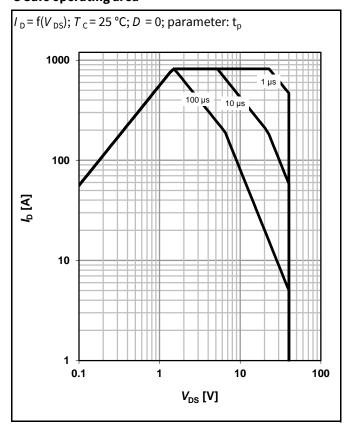
#### 1 Power dissipation



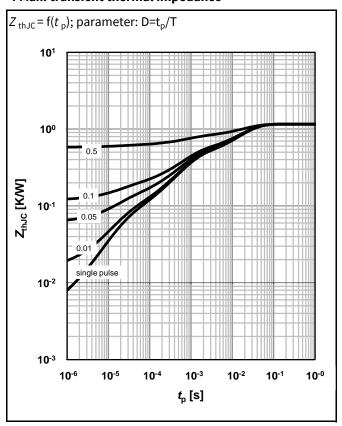
#### 2 Drain current



### 3 Safe operating area

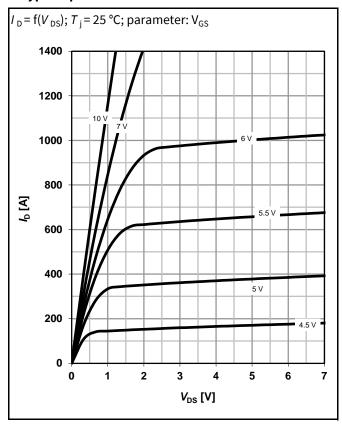


#### 4 Max. transient thermal impedance

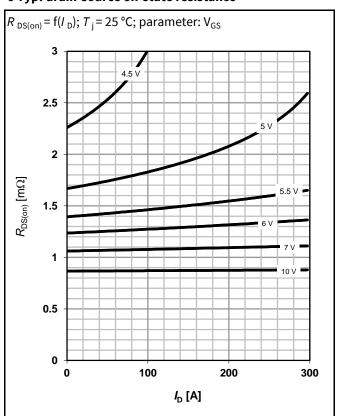




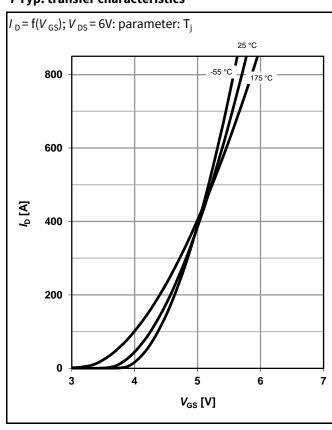
#### 5 Typ. output characteristics



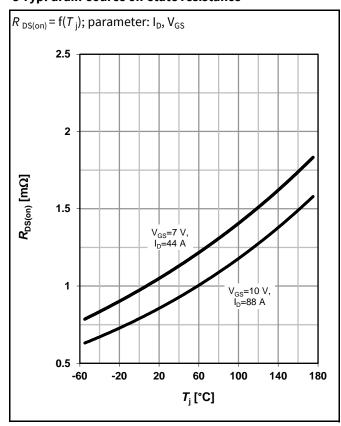
#### 6 Typ. drain-source on-state resistance



#### 7 Typ. transfer characteristics

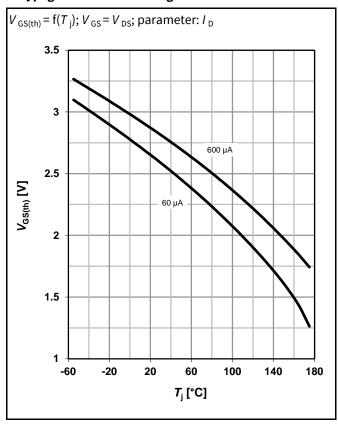


### 8 Typ. drain-source on-state resistance

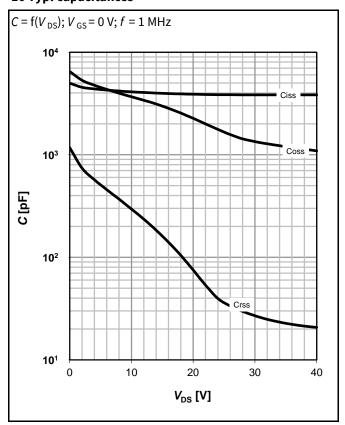


# infineon

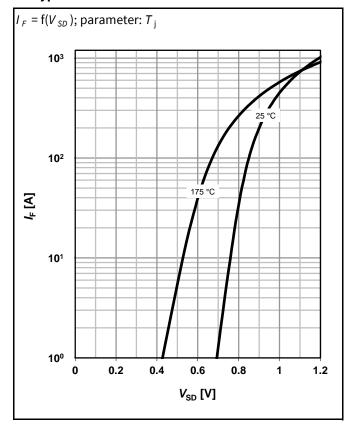
#### 9 Typ. gate threshold voltage



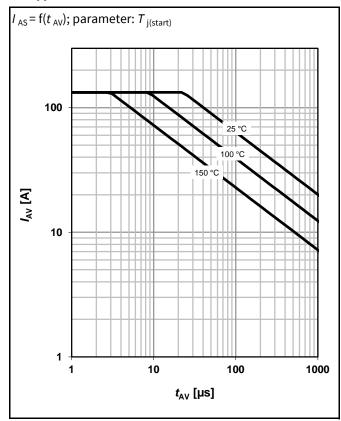
#### 10 Typ. capacitances



#### 11 Typical forward diode characteristics

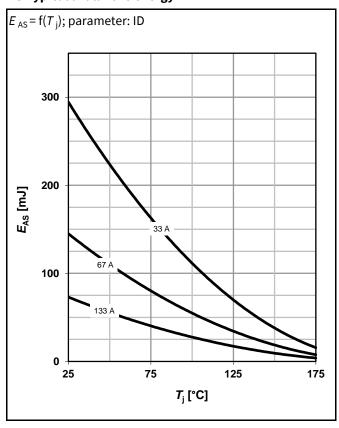


#### 12 Typ. avalanche characteristics

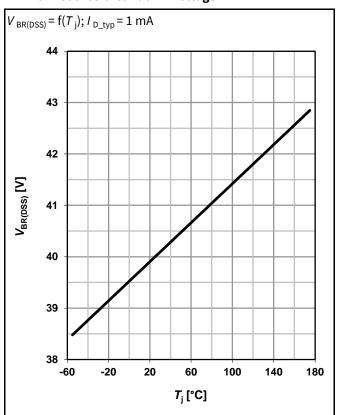


# infineon

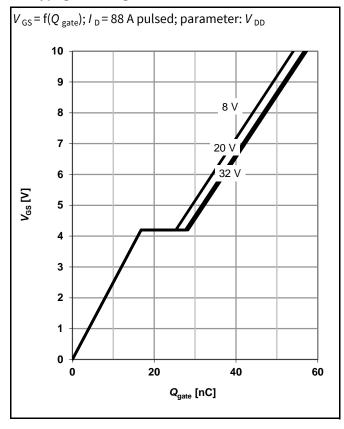
#### 13 Typical avalanche energy



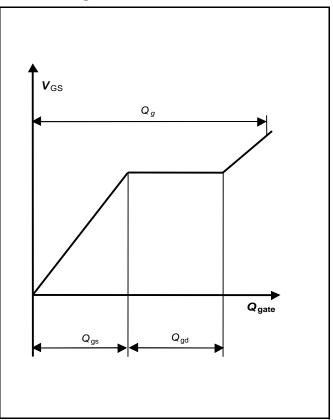
#### 14 Drain-source breakdown voltage



#### 15 Typ. gate charge

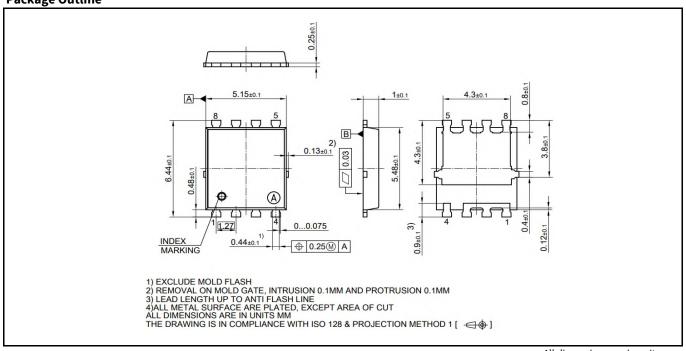


#### 16 Gate charge waveforms



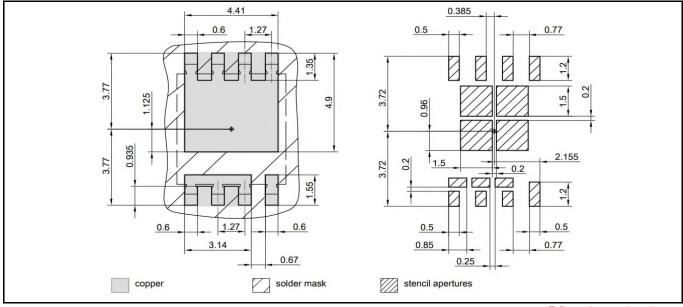


**Package Outline** 



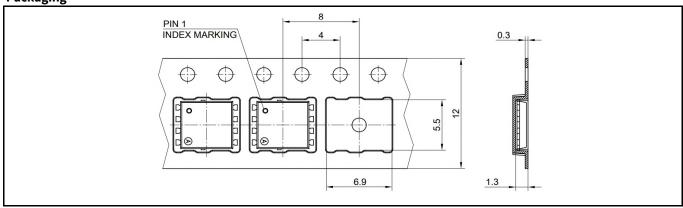
All dimensions are in units mm

#### **Footprint**



All dimensions are in units mm

#### **Packaging**



All dimensions are in units mm

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## **Revision History**

Revision	Date	Changes	
Revision 1.0	15.11.2023	Final Data Sheet	

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